Resonator

Piezoelectric Resonator (8 to 16 MHz)

FAR Family (C4 series G type)

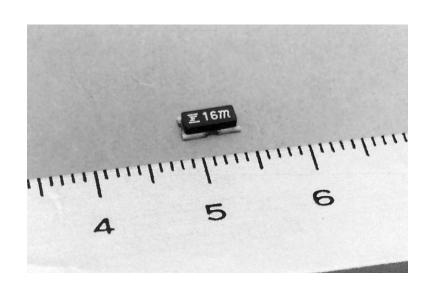
■ DESCRIPTION

Fujitsu resonators C4 series (G type) feature originally developed single crystals with a high electromechanical coefficient (LiNbO₃ lithium niobate), the result is ultra compact packaging. C4 series (G type) with built-in capacitors for exclusive use in microcomputer clocks, and this series is chip type device for surface-mount.

■ FEATURES

- Ultra compact package.
- Wide frequency range in 8 to 16 MHz.
- C4 (G type), with built-in capacitors, is the best suited to the source of microcomputer clocks.
- C4 (G type) can be shipped in emboss-typed packages for automatic mounting.
- The resonators have superior shock and vibration resistance, preventing damage during automatic mounting process.

■ PACKAGE



■ STANDARD CHARACTERISTICS

Series Parameter	C4 series (G type)	Remarks				
Material	Lithium Niobate (LiNbO ₃)					
Frequency	8 to 16 MHz					
Standard frequency	See "■ Standard Frequency."					
Initial frequency deviation	±0.5% (µ)					
Temperature characteristics (–20°C to 60°C)	±0.5%					
Capacity of built-in capacitor	20±8 pF (Standard)	10±4 pF type are also available. However, the characteristics of 10±4 pF type should be specified by Fujitsu, considering matching data with applied IC (mainly microcomputer.)				
Aging stability	Within ±0.1%					
Operating temperature	−30°C to +85°C					
Storage temperature	−40°C to +100°C					
Standard measuring circuit	(1) Oscillation frequency	(2) Serial resonant resistance				
	1 MΩ 1 C1 C2	R 75Ω C_1 C_2 $T_5\Omega$ D				
	8 MHz to 10 MHz IC: 1/6 MB84069B x 2	Measuring equipment: Network analyzer R: Resonator				
	10 MHz to 16 MHz IC: 1/6 MC74HC04 x 2					
	 Vcc=5 V DC R : Resonator C1, C2 : Loading capacitance (built-in)				

■ STANDARD FREQUENCY

Standard frequency (KHz)	Package size	Resonant resistance
8,000 10,000	G	100 Ω max. (Symbol: 5)
11,000 11,059 12,000 16,000	G	75 Ω max. (Symbol: 2)

Note: • For oscillation frequency (in 8 to 16 MHz) other than standard, Fujitsu can also develop applicable part.

• Resonant resistance of the part is specified according to applied frequency as above.

■ NOTES ON USE

- Handle carefully
- Solder under the following conditions.
 5 seconds max. at 230°C (PCB)
 - Do not apply extreme heat to the resonator. Recommended preheating is 150°C for one minute.
- Avoid extreme fluctuations in temperature during use.
- There is no specific direction in resonator mounting.
- Oscillation data should be examined when used in oscillation circuit with micon or other ICs.
- This is for reflow solder, not for flow solder.

■ PART NUMBERING SYSTEM

 $\mathsf{FAR} - \mathsf{C4} \quad \mathsf{C} \quad \mathsf{G} - \square \square \square \square \square - \square \quad \square \quad \square \quad - \mathsf{R}$ (1) (2) (3) (5) (6) (7) (8) (9)

(1) Series

Series	Single crystal	Capacitor		
C4	LiNbO ₃	With built-in capacitors		

(2) Package Type

Specification	Туре				
С	Chip type				

(3) Package Size

Specification	Size
G	G type(Ultra compact)

(4) Frequency (KHz) See "■ Standard Frequency." [Example] 8.0 MHz 08000

(5) Initial Frequency Deviation

Specification	Deviation				
M	±0.5%				

(6) Built-in Capacitor

Specification	Capacitance
0	20±8 pF
1	10±4 pF

(7) Resonant Resistance

Specification	Resonant resistance				
2	75 Ω max.				
5	100 Ω max.				

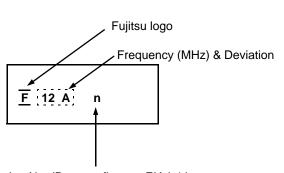
(8) User-specific Special Symbols

Specification	Description				
Name	No specification, no taping specification				
_	No specification, with taping specification				
A to Z	Serial number for custom design				

(9) Taping Specification

Specification	Description				
R	12 mm width tape & reel				

■ MARKING



The stamp color varies according to built-in capacitor.

	Marking color
10 pF	Yellow
20 pF	White

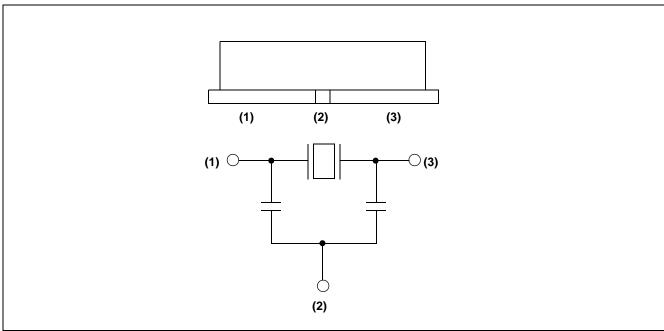
Lot No. (Date confirms to EIAJ. *)

*EIAJ RC1001 standard

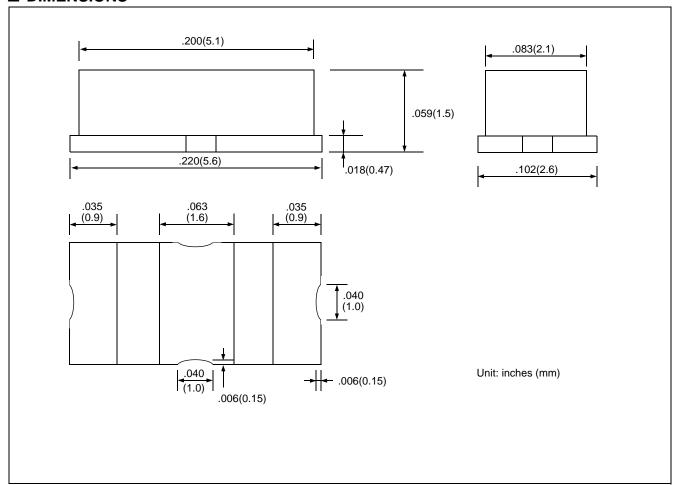
Year	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
1993	Α	В	С	D	Е	F	G	Н	J	K	L	М
1994	Ν	Ρ	Q	R	S	Т	U	V	W	Χ	Υ	Ζ
1995	а	b	\overline{c}	d	е	f	9	h	j	k	Q	М
1996	n	P	q	r	1	t	u	U	W	α	4	3

Note: The code on and after Jan 1997 is specified repeatedly from "A".

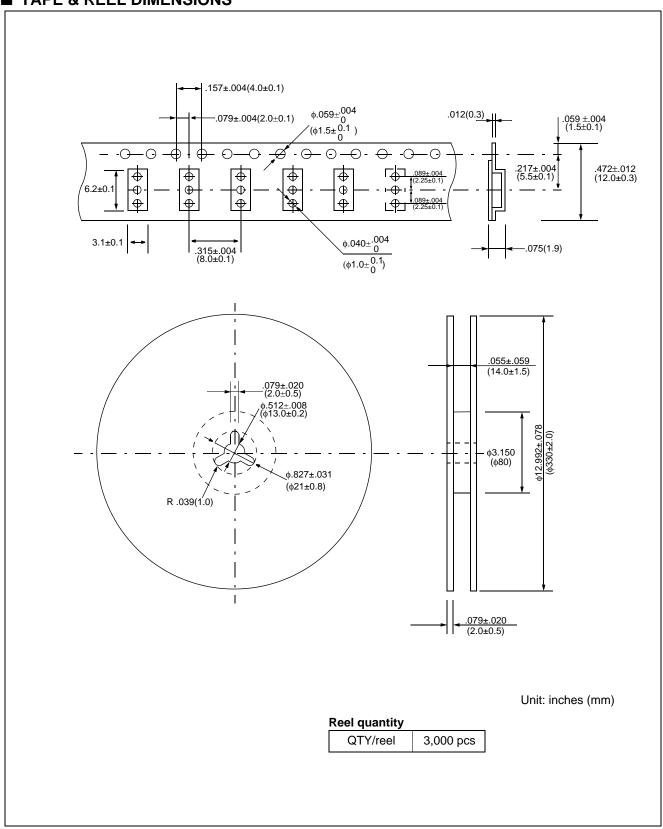
■ PIN ASSIGNMENT



■ DIMENSIONS

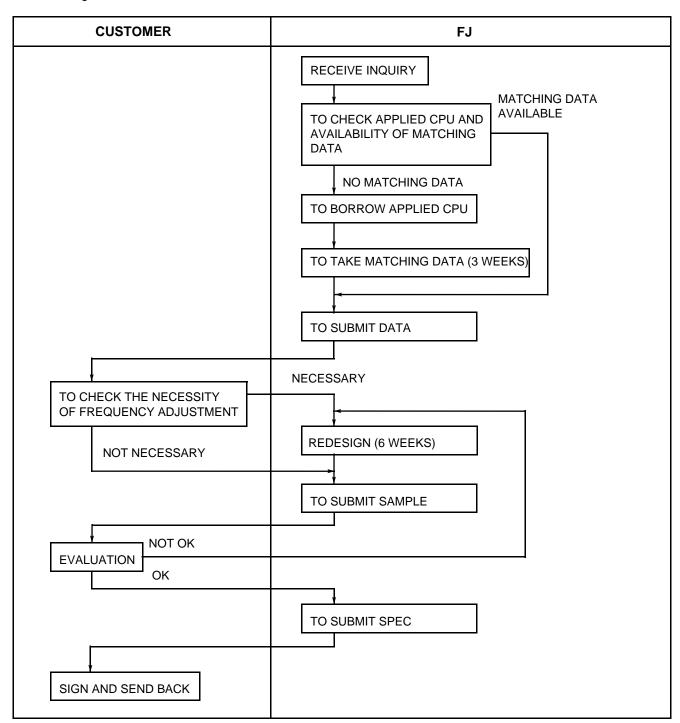


■ TAPE & REEL DIMENSIONS



■ RESONATOR BUSINESS FLOW CHART

Oscillation frequency should be varied according to applied micro controller or another IC's. Fujitsu should recommend the resonator parts considering matching condition with applied IC. Following shows business flow chart.



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